## 22454

## 22223 3 Hours / 70 Marks Seat No.

- Instructions (1) All Questions are Compulsory.
  - (2) Answer each next main Question on a new page.
  - (3) Illustrate your answers with neat sketches wherever necessary.
  - (4) Figures to the right indicate full marks.
  - (5) Mobile Phone, Pager and any other Electronic Communication devices are not permissible in Examination Hall.
  - (6) Abbreviations used has their usual meaning.

Marks

## 1. Attempt any FIVE of the following:

10

- a) State any four advantages of plastic packaging.
- b) Enlist any four advantages of flexible packaging.
- c) State any four properties of moulded PS foam.
- d) Enlist four products which in packaged in Pu foam.
- e) Draw neat sketch of drape forming.
- f) Suggest four solvents used for solvent sealing.
- g) Enlist the text method for rigid and flexible packaging.

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		Mai	rks	
2.		Attempt any THREE of the following:	12	
	a)	Suggest special requirements for food and medical packaging (minimum four for each)		
	b)	Explain extrusion coating method with neat sketch.		
	c)	Explain with neat sketch the plug-assist thermoforming process		
	d)	Explain with neat sketch the vacuum metalization process.		
3.		Attempt any THREE of the following:	12	
	a)	Describe stress crack resistance test for packaging.		
	b)	State the selection criteria for packaging materials.		
	c)	State four flexible packaging foods with reason behind its flexible packaging.		
	d)	Explain with neat sketch the matched mould thermoforming process.		
4.		Attempt any THREE of the following:	12	
	a)	Explain with neat sketch the hot melt sealing process.		
	b)	State any four hazards of packaging with their control measures.		
	c)	Describe with neat sketch the blown film extrusion process.		
	d)	Explain with neat sketch the dual sheet thermoforming process.		
	e)	Explain blister packaging with neat sketch.		
5.		Attempt any <u>TWO</u> of the following:	12	
	a)	State any two properties and two applications of following packaging plastics.		
		i) PVDC		
		ii) EVOH		
		iii) PC		
	b)	Explain with neat sketch the multi layer film extrusion process.		
	c)	Explain with neat sketch the sketch wrapping process.		

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		Marks
6.	Attempt any TWO of the following:	12

- a) Explain with neat sketch the stack load test for packaging.
- b) Explain vacuum snap-back thermoforming with neat sketch.
- c) Explain flexographic printing with neat sketch.